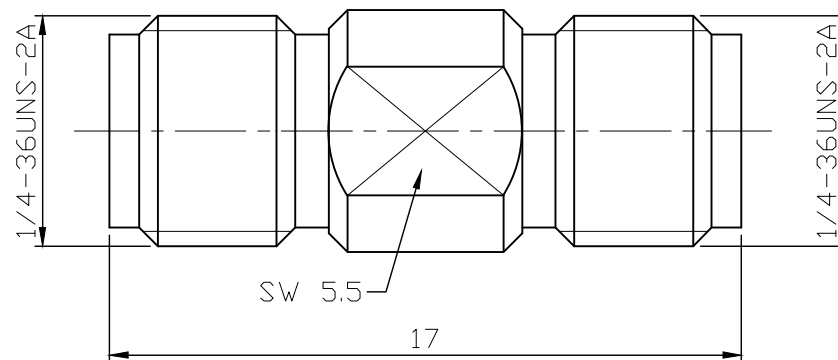


REVISION				
ASS. REV.	CON. REV.	DESCRIPTON	DATE	APPROVED
N/A	-	INITIAL RELEASE	2020/08/13	



VSWR 1.35 : 1 MAX UP TO 18GHz

NOTES: FINISH (PLATING THICKNESS IN MICRO-INCHES)

1. BRASS.
2. BERYLLIUM COPPER.
3. HIGH DENSITY POLYETHYLENE
4. GOLD PL. 4 MIN. OVER NICKEL-PHOSPHORUS ALLOY PL. 80 MIN. OVER COPPER PL. 20 MIN.

2. BERYLLIUM COPPER. 3. HIGH DENSITY POLYETHYLENE 4. GOLD PL. 4 MIN. OVER NICKEL-PHOSPHORUS ALLOY PL. 80 MIN. OVER COPPER PL. 20 MIN.							DIMENSION ARE MILLIMETERS UNLESS OTHERWISE SPECIFIED TOLERANCES (UNIT: MM) 0~0.5 = ±0.03 0.5~5 = ±0.05 5~10 = ±0.07 10~20 = ±0.10 20~30 = ±0.15 30~ = ±0.20	SCALE	ASSEMBLY REV.	CONNECTOR REV.	UNIT	JYE BAO CO., LTD. TAIPEI TAIWAN
								5 / 1	N/A	—	MM	
								APPROVED				DATE
								CHECKED		TESTER		TITLE
								DATE		DATE		SMA JACK TO SMA JACK
								DRAWING				DRAWING NO.
							DATE				AD-A8A8-A1/HDPE	
3	CONTACT PIN	NOTE 2	NOTE 4	1	A8A8-BFS-17-2/10G/NM	—						
2	INSULATOR	NOTE 3		2	SMA-HDPE5	—						
1	BODY	NOTE 1	NOTE 4	1	AD-A8A8-A1-1/NM	A						
NO.	DESCRIPTION	MATERIAL	FINISH	Q'TY	PART NO.	REV						